

<b>PATENT ASSIGNMENT COVER SHEET</b>
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Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6988329

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JIEUN MYUNG	09/27/2021
DAHUN LEE	09/29/2021
JUNHO JIN	09/27/2021
BOSOOK KANG	09/29/2021
JINHOO LEE	09/27/2021
JUNWON LEE	09/27/2021
NAMSU KIM	09/27/2021
JIYUN LIM	09/30/2021
KANGMOON KIM	09/29/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SAMSUNG ELECTRONICS CO., LTD.
<b>Street Address:</b>	129, SAMSUNG-RO
<b>Internal Address:</b>	YEONGTONG-GU
<b>City:</b>	SUWON-SI, GYEONGGI-DO
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	16677
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29812286
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(312)775-8100
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	3127758000
<b>Email:</b>	mhmpto@mcandrews-ip.com
<b>Correspondent Name:</b>	MCANDREWS HELD & MALLOY, LTD.
<b>Address Line 1:</b>	500 W. MADISON ST.
<b>Address Line 2:</b>	34TH FLOOR
<b>Address Line 4:</b>	CHICAGO, ILLINOIS 60661
<b>ATTORNEY DOCKET NUMBER:</b>	65974US01

PATENT

<b>NAME OF SUBMITTER:</b>	CHRISTOPHER V. CARANI
<b>SIGNATURE:</b>	/Christopher V. Carani/
<b>DATE SIGNED:</b>	10/26/2021
<b>Total Attachments: 11</b> source=SD210299US_65974US01_CDA#page1.tif source=SD210299US_65974US01_CDA#page2.tif source=SD210299US_65974US01_CDA#page3.tif source=SD210299US_65974US01_CDA#page4.tif source=SD210299US_65974US01_CDA#page5.tif source=SD210299US_65974US01_CDA#page6.tif source=SD210299US_65974US01_CDA#page7.tif source=SD210299US_65974US01_CDA#page8.tif source=SD210299US_65974US01_CDA#page9.tif source=SD210299US_65974US01_CDA#page10.tif source=SD210299US_65974US01_CDA#page11.tif	

COMBINED DECLARATION (37 CFR §1.63) FOR UTILITY OR DESIGN PATENT APPLICATION  
AND ASSIGNMENT FORM<sup>1</sup>

The undersigned acknowledges that this document is being used both as an assignment of the invention and as the declaration (37 CFR 1.63) for a Utility or Design Application.

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has invented:

Title: Case for Portable Electronic Device

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for which Assignor is about to make or has made United States or International application for patent.

WHEREAS, as a below named inventor(s), I/(we) hereby declare that:

Section I. Declaration

This declaration is directed to:

- The attached U.S. non-provisional patent application, or
- U.S. non-provisional patent application number 29/812,286, filed on October 20, 2021, or
- PCT international patent application number \_\_\_\_\_, filed on \_\_\_\_\_.

The above-identified application was made or authorized to be made by me (us).

I (we) believe that I am (we are) the original inventor (original joint inventors) of a claimed invention in the above-identified application.

I (we) hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

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<sup>1</sup> This form requires the use of an Application Data Sheet.

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Attorney Ref No. 65974US01 (SD210299US)

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims.

I acknowledge that I am aware of the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

**Section II. Assignment**

In consideration of and according to the provisions of the Assignor's employment agreement(s), the undersigned hereby sell(s) and assign(s) to

Samsung Electronics Co., Ltd.

having an address at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do 16677, Republic of Korea (hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention or design described in the application identified in Section I of this document.

Assignor hereby confirms any prior assignment to Assignee, and to the extent that Assignor has not already done so, agrees to assign, and hereby does, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions or designs as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of

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Attorney Ref No.

65974US01 (SD210299US)


protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

Assignor hereby covenants that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

Assignor hereby requests the United States Patent and Trademark Office to issue the Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue the Letters Patent, Utility Model Registration or other similar right to Assignee.


The undersigned hereby grant(s) the law firm of McAndrews, Held & Malloy, Ltd. the power to insert on this Declaration and Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

Section III. Inventor(s)/Assignor(s) Signature(s)

LEGAL NAME OF FIRST INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	MYUNG	Jieun	
SIGNATURE  DATE <u>September 19, 2021</u>			

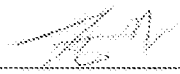
Attorney Ref No. 65974US01 (SD210299US)

LEGAL NAME OF SECOND INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	LEE	Dahyun	

SIGNATURE  DATE September 29, 2007

Attorney Ref No. 65974US01 (SD210299US)

LEGAL NAME OF THIRD INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	JIN	Junho	

SIGNATURE  DATE September 27, 2001

Attorney Ref No. 65974US01 (SD210299US)

LEGAL NAME OF FOURTH INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	KANG	Bosoon	


SIGNATURE *[Handwritten Signature]*

DATE *September 21, 2021*

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Attorney Ref No. 65974US01 (SD210299US)



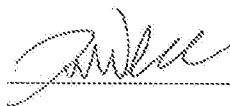
LEGAL NAME OF FIFTH INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	LEE	Jinhoo	
<p data-bbox="381 489 527 520">SIGNATURE </p> <p data-bbox="1036 464 1105 491">DATE <u>September 27, 2004</u></p>			

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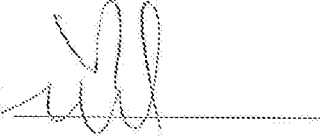
Attorney Ref No. 65974US01 (SD210299US)

LEGAL NAME OF SIXTH INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	LEE	Junwon	


  

SIGNATURE		DATE	September 29, 2007
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Attorney Ref No. 65974US01 (SD210299US)

LEGAL NAME OF SEVENTH INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	KIM	Namsu	
<p data-bbox="386 485 532 516">SIGNATURE </p> <p data-bbox="1040 464 1105 489">DATE <u>September 21, 2021</u></p>			

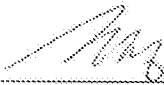
Attorney Ref No. 65974US01 (SD210299US)

LEGAL NAME OF EIGHTH INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	LIM	Jiyun	
<p data-bbox="394 478 537 510">SIGNATURE </p> <p data-bbox="1049 457 1409 527">DATE <u>September 30, 2011</u></p>			

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Attorney Ref No. 65974US01 (SD210299US)

LEGAL NAME OF NINTH INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	KIM	Kangmoon	

SIGNATURE 

DATE September 29, 2021

Attorney Ref No. 65974US01 (SD210299US)